

1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608ZGCK Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

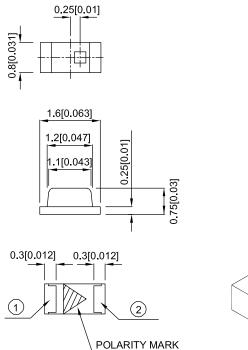
Descriptions

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
 - Electrostatic discharge and power surge could damage the LEDs.
 - It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
 - All devices, equipments and machineries must be electrically grounded.

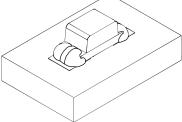
Features

- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
APT1608ZGCK	Green (InGaN)	Water Clear	200	350	120°

- 1. 01 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
 2. Luminous intensity / luminous Flux: + / -15%.
 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	I==20mA
λD [1]	Dominant Wavelength	Green	525		nm	I==20mA
Δλ1/2	Spectral Line Half-width	Green	35		nm	I==20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	I==20mA
lr	Reverse Current	Green		50	uA	V _R =5V

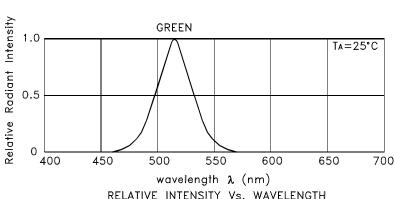
- Notes:
 1. Wavelength: + / -1nm.
 2. Forward Voltage: + / -0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units	
Power dissipation	102.5	mW	
DC Forward Current	25	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

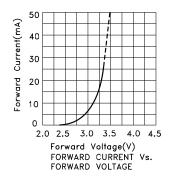
Note: 1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.

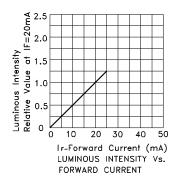
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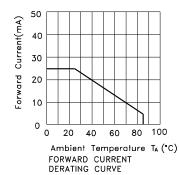


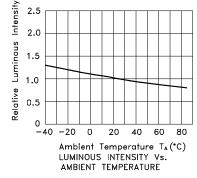
RELATIVE INTENSITY Vs. WAVELENGTH

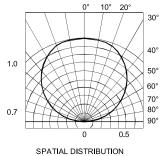
Green APT1608ZGCK









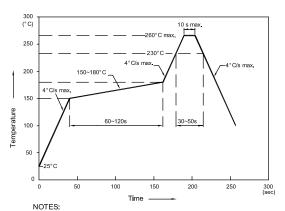


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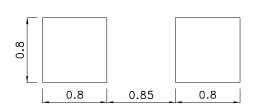
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

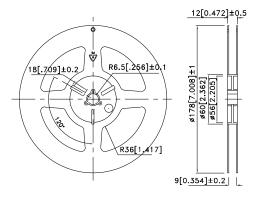


- 1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed
- to high temperature.
 3.Number of reflow process shall be 2 times or less.

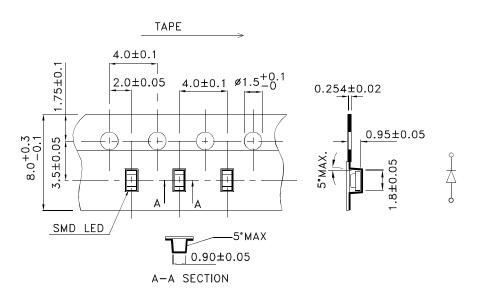
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)

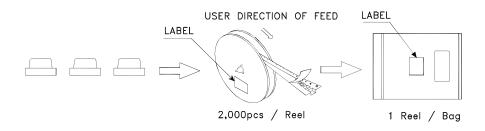


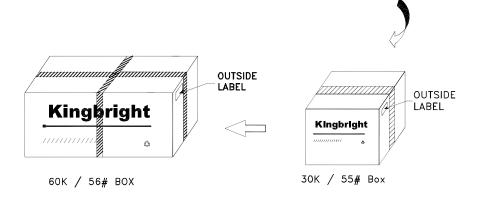
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PACKING & LABEL SPECIFICATIONS

APT1608ZGCK







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